








POLYPHENYLENE ETHER RESIN COMPOSITIONS CONTAINING SILICON COMPOUNDS

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Inventor: SAITO HIDEO [JP]; IKEDA MASANORI [JP]
Applicant: ASAHI CHEMICAL IND [JP];; SAITO HIDEO [JP];;
IKEDA MASANORI [JP]
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Abstract of WO02059208

A polyphenylene ether resin composition comprising a polyphenylene ether resin and at least one member selected from among cage-type silsesquioxanes and products of partial cleavage thereof. This composition is excellent in heat resistance, mechanical properties, moldability and flame retardance.

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